

## Metallized Paper (MP) RFI-Capacitors Class Y2 PCM 10 mm and 15 mm

### Special Features

- Particularly high reliability against active and passive flammability
- Excellent self-healing as well as high voltage strength
- High degree of interference suppression due to good attenuation and low ESR
- For temperatures up to +110° C
- According to RoHS 2002/95/EC

### Typical Applications

Class Y2 RFI applications to meet EMC regulations

- Capacitors connected to the mains between phase or neutral and earthed casing
- By-passing of the basic or supplementary insulation, pulse peak voltage  $\leq 5$  kV

### Construction

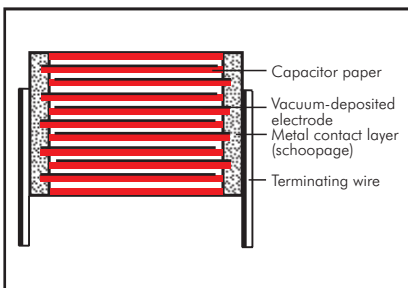
#### Dielectric:

Paper, epoxy resin impregnated

#### Capacitor electrodes:

Vacuum-deposited

#### Internal construction:



#### Encapsulation:

Self-extinguishing epoxy resin, UL 94 V-0, metal foil

#### Terminations:

Tinned wire.

#### Marking:

Marking: Black on Silver.

### Electrical Data

#### Capacitance range:

1000 pF to 0.022  $\mu$ F (E12-values on request)

#### Rated voltages:

250 VAC

#### Capacitance tolerances:

$\pm 20\%$

#### Operating temperature range:

-40° C to +110° C

#### Climatic test category:

40/110/56/C in accordance with IEC

#### Insulation resistance at +20° C:

$\geq 12 \times 10^3$  M $\Omega$

Measuring voltage: 100 V/1 min.

#### Dissipation factors:

$\tan \delta \leq 13 \times 10^{-3}$  at 1 kHz and +20° C

#### Test specifications:

In accordance with DIN EN 132400

#### Approvals:

Country	Authority	Specification	Symbol	Approval-No.
Germany	VDE	DIN EN 132400 IEC 60384-14/2		87455
USA	UL	UL 1283		E 100438
Canada	CSA	C 22.2 No. 8		LR 93312-1

#### Maximum pulse rise time:

Capacitance pF/ $\mu$ F	Pulse rise time V/ $\mu$ sec max. operation
1000	1000
1500	600
2200 ... 4700	450
6800 ... 0.022	300

for pulses equal to the rated voltage,  $U_{pp} = 355$  V

**Test voltage:** 2700 VDC, 2 sec.

#### Reliability:

Operational life > 300 000 hours

Failure rate < 1 fit (0.5 x  $U_r$  and 40° C)

### Packing

Available taped and reeled.

Detailed taping information and graphs at the end of the catalogue.

For further details and graphs please refer to Technical Information.

## Continuation

### General Data

Capacitance	250 VAC*			
	W	H	L	PCM**
1000 pF	4	8.5	13.5	10
1500 „	4	8.5	13.5	10
2200 „	4	8.5	13.5	10
3300 „	4	8.5	13.5	10
4700 „	5	10	13.5	10
6800 „	5	13	19	15
0.01 $\mu$ F	5	13	19	15
0.015 „	6	14	19	15
0.022 „	7	15	19	15

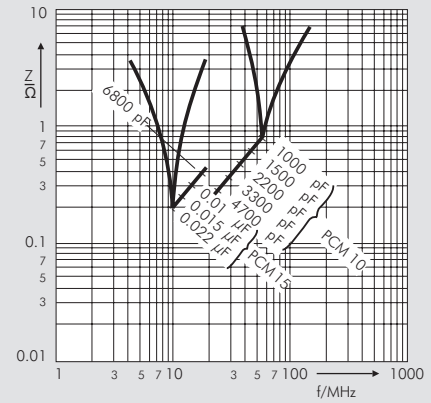
\*  $f = 50/60$  Hz

\*\* PCM = Printed circuit module = lead spacing

Upon request with long leads 35-2 mm max.

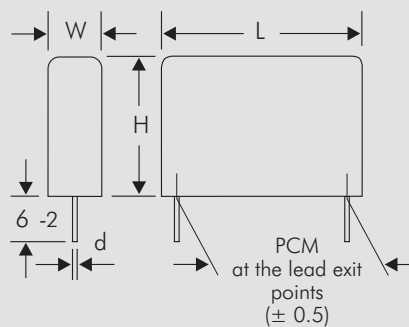
Dims. in mm.

Taped version see page 100.



Impedance change with frequency  
(general guide)

$d = 0.7 \varnothing$  if PCM 10  
 $d = 0.8 \varnothing$  if PCM 15



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## Recommendation for Processing and Application of Through-Hole Capacitors

### Soldering Process

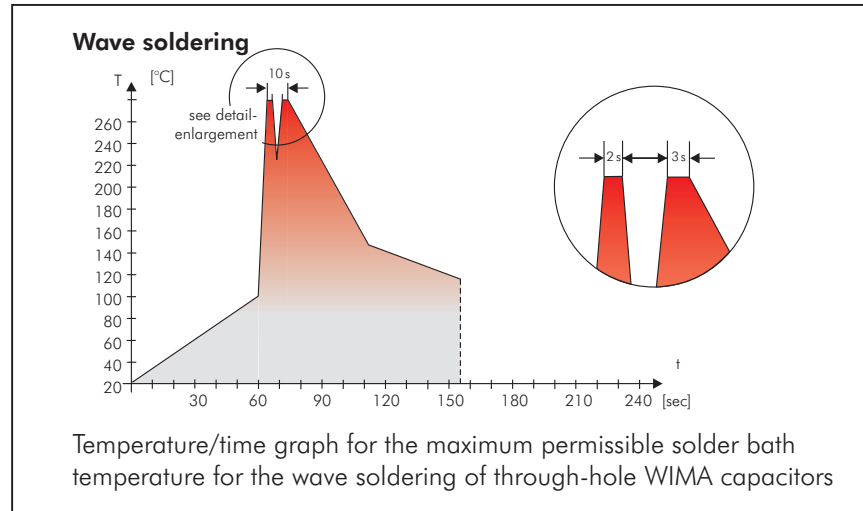
A preheating of through-hole WIMA capacitors is allowed for temperatures  $T_{\max} < 100^{\circ}\text{C}$ .  
In practice a preheating duration of  $t < 5$  min. has been proven to be best.

#### Single wave soldering

Soldering bath temperature:  $T < 260^{\circ}\text{C}$   
Immersion time:  $t < 5$  sec

#### Double wave soldering

Soldering bath temperature:  $T < 260^{\circ}\text{C}$   
Immersion time:  $2 \times t < 3$  sec



## WIMA Quality and Environmental Philosophy

### ISO 9001:2000 Certification

ISO 9001:2000 is an international basic standard of quality assurance systems for all branches of industry. The approval according to ISO 9001:2000 of our factories by the VDE inspectorate certifies that organisation, equipment and monitoring of quality assurance in our factories correspond to internationally recognized standards.

### WIMA WPCS

The WIMA Process Control System (WPCS) is a quality surveillance and optimization system developed by WIMA. WPCS is a major part of the quality-oriented WIMA production. Points of application of WPCS during production process:

- incoming material inspection
- metallization
- film inspection
- schoopage
- pre-healing
- lead attachment
- cast resin preparation/encapsulation
- 100% final inspection
- AQL check

### WIMA Environmental Policy

All WIMA capacitors, irrespective of whether through-hole devices or SMD, are made of environmentally friendly materials. Neither during manufacture nor in the product itself any toxic substances are used, e.g.

- Lead
- PCB
- CFC
- Hydrocarbon chloride
- Chromium 6+
- PBB/PBDE
- Arsenic
- Cadmium
- Mercury
- etc.

We merely use pure, recyclable materials for packing our components, such as:

- carton
- cardboard
- adhesive tape made of paper
- polystyrene

We almost completely refrain from using packing materials such as:

- foamed polystyrene (Styropor®)
- adhesive tapes made of plastic
- metal clips

### RoHS Compliance

According to the RoHS Directive 2002/95/EC certain hazardous substances like e.g. lead, cadmium, mercury must not be used any longer in electronic equipment as of July 1st, 2006. For the sake of the environment WIMA has refrained from using such substances since years already.



WIMA Kondensatoren sind bleifrei konform RoHS 2002/95/EG

WIMA capacitors are lead free in accordance with RoHS 2002/95/EC

Tape for lead-free WIMA capacitors

### ISO 14001:2005

WIMA's environmental management has been established in accordance with the guidelines of ISO 14001. The certification is under preparation and is expected to be accomplished by June 2006.

# Typical Dimensions for Taping Configuration

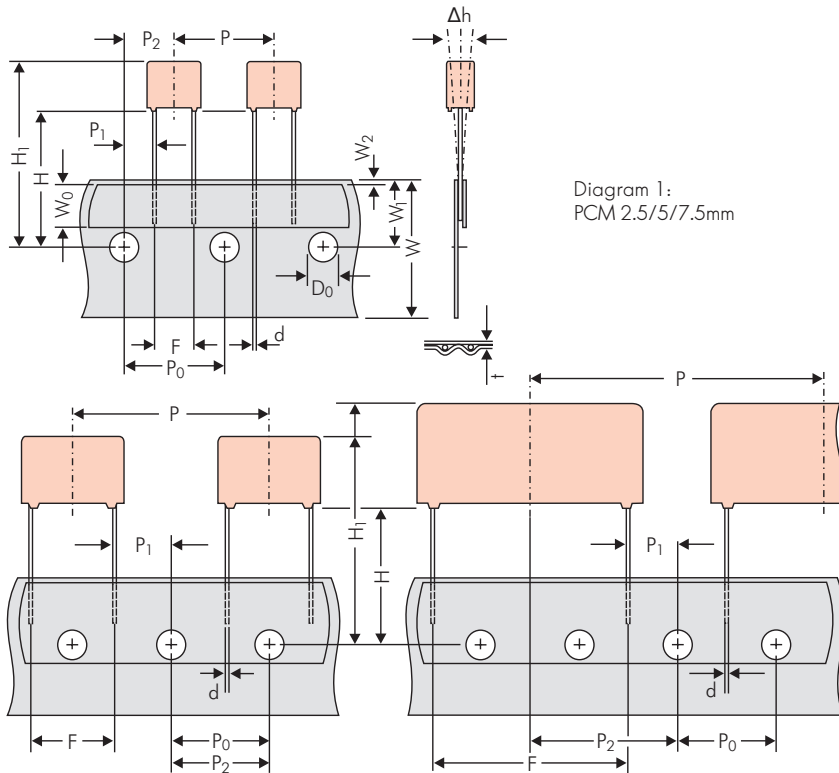


Diagram 2: PCM 10/15 mm

Diagram 3: PCM 22.5 and 27.5\*mm

\*PCM 27.5 taping possible with two feed holes between components

Designation	Symbol	Dimensions for Radial Taping						
		PCM 2.5 taping	PCM 5 taping	PCM 7.5 taping	PCM 10 taping*	PCM 15 taping*	PCM 22.5 taping	PCM 27.5 taping
Carrier tape width	W	18.0 ±0.5	18.0 ±0.5	18.0 ±0.5	18.0 ±0.5	18.0 ±0.5	18.0 ±0.5	18.0 ±0.5
Hold-down tape width	W <sub>0</sub>	6.0 for hot-sealing adhesive tape	6.0 for hot-sealing adhesive tape	12.0 for hot-sealing adhesive tape	12.0 for hot-sealing adhesive tape	12.0 for hot-sealing adhesive tape	12.0 for hot-sealing adhesive tape	12.0 for hot-sealing adhesive tape
Hole position	W <sub>1</sub>	9.0 ±0.5	9.0 ±0.5	9.0 ±0.5	9.0 ±0.5	9.0 ±0.5	9.0 ±0.5	9.0 ±0.5
Hold-down tape position	W <sub>2</sub>	0.5 to 3.0 max.	0.5 to 3.0 max.	0.5 to 3.0 max.	0.5 to 3.0 max.	0.5 to 3.0 max.	0.5 to 3.0 max.	0.5 to 3.0 max.
Feed hole diameter	D <sub>0</sub>	4.0 ±0.2	4.0 ±0.2	4.0 ±0.2	4.0 ±0.2	4.0 ±0.2	4.0 ±0.2	4.0 ±0.2
Pitch of component	P	12.7 ±1.0	12.7 ±1.0	12.7 ±1.0	25.4 ±1.0	25.4 ±1.0	38.1 ±1.5	38.1 ±1.5 or 50.8 ±1.5
Feed hole pitch	P <sub>0</sub>	12.7 ±0.3 cumulative pitch error max. 1.0 mm/20 pitch	12.7 ±0.3 cumulative pitch error max. 1.0 mm/20 pitch	12.7 ±0.3 cumulative pitch error max. 1.0 mm/20 pitch	12.7 ±0.3 cumulative pitch error max. 1.0 mm/20 pitch	12.7 ±0.3 cumulative pitch error max. 1.0 mm/20 pitch	12.7 ±0.3 cumulative pitch error max. 1.0 mm/20 pitch	12.7 ±0.3 cumulative pitch error max. 1.0 mm/20 pitch
Feed hole centre to lead	P <sub>1</sub>	5.1 ±0.5	3.85 ±0.7	2.6 ±0.7	7.7 ±0.7	5.2 ±0.7	7.8 ±0.7	5.3 ±0.7
Hole centre to component centre	P <sub>2</sub>	6.35 ±1.3	6.35 ±1.3	6.35 ±1.3	12.7 ±1.3	12.7 ±1.3	19.05 ±1.3	19.05 ±1.3
Feed hole centre to bottom edge of the component	H <sub>▲</sub>	16.5 ±0.3 18.5 ±0.5	16.5 ±0.3 18.5 ±0.5	16.5 ±0.5 18.5 ±0.5	16.5 ±0.5 18.5 ±0.5	16.5 ±0.5 18.5 ±0.5	16.5 ±0.5 18.5 ±0.5	16.5 ±0.5 18.5 ±0.5
Feed hole centre to top edge of the component	H <sub>1</sub>	H+H <sub>component</sub> < H <sub>1</sub> 32.25 max.	H+H <sub>component</sub> < H <sub>1</sub> 32.25 max.	H+H <sub>component</sub> < H <sub>1</sub> 24.5 to 31.5	H+H <sub>component</sub> < H <sub>1</sub> 25.0 to 31.5	H+H <sub>component</sub> < H <sub>1</sub> 26.0 to 37.0	H+H <sub>component</sub> < H <sub>1</sub> 30.0 to 43.0	H+H <sub>component</sub> < H <sub>1</sub> 35.0 to 45.0
Lead spacing at upper edge of carrier tape	F	2.5 ±0.5	5.0 <sup>+0.8</sup> <sub>-0.2</sub>	7.5 ±0.8	10.0 ±0.8	15 ±0.8	22.5 ±0.8	27.5 ±0.8
Lead diameter	d	0.4 ±0.05	0.5 ±0.05	0.5 ±0.05 or 0.7 <sup>+0.07</sup> <sub>-0.05</sub>	0.5 ±0.05 or 0.7 <sup>+0.07</sup> <sub>-0.05</sub>	0.8 <sup>+0.08</sup> <sub>-0.05</sub>	0.8 <sup>+0.08</sup> <sub>-0.05</sub>	0.8 <sup>+0.08</sup> <sub>-0.05</sub> or 1.0 <sup>+0.1</sup> <sub>-0.05</sub>
Component alignment	Δh	± 2.0 max.	± 2.0 max.	± 3.0 max.	± 3.0 max.	± 3.0 max.	± 3.0 max.	± 3.0 max.
Total tape thickness	t	0.7 ±0.2	0.7 ±0.2	0.7 ±0.2	0.7 ±0.2	0.7 ±0.2	0.7 ±0.2	0.7 ±0.2
Package (see also page 1011)	▲	ROLL/AMMO			AMMO			
		REEL ø 360 max. ø 30 ±1	B 52 ±2 58 ±2 } depending on comp. dimensions		REEL ø 360 max. ø 30 ±1	B 52 ±2 58 ±2 or 66 ±2	REEL ø 500 max. ø 25 ±1	B 60 ±2 68 ±2 } depending on PCM and component dimensions
Unit		see details page 103.						

▲ Please give „H“ dimensions and desired packaging type when ordering.

• Diameter of leads see General Data.

\* PCM 10 and PCM 15 can be crimped to PCM 7.5.

Position of components according to PCM 7.5 (sketch 11). P<sub>0</sub> = 12.7 or 15.0 is possible

Dims in mm.

Please clarify customer-specific deviations with the manufacturer.